

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Zvi Or-Bach</td> <td>09/25/2012</td> </tr> <tr> <td>Deepak Sekar</td> <td>09/26/2012</td> </tr> <tr> <td>Brian Cronquist</td> <td>09/25/2012</td> </tr> <tr> <td>Ze'ev Wurman</td> <td>09/25/2012</td> </tr> </tbody> </table>		Name	Execution Date	Zvi Or-Bach	09/25/2012	Deepak Sekar	09/26/2012	Brian Cronquist	09/25/2012	Ze'ev Wurman	09/25/2012
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>MonolithIC 3D Inc.</td> </tr> <tr> <td>Street Address:</td> <td>3555 Woodford Drive</td> </tr> <tr> <td>City:</td> <td>San Jose</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>95124</td> </tr> </table>		Name:	MonolithIC 3D Inc.	Street Address:	3555 Woodford Drive	City:	San Jose	State/Country:	CALIFORNIA	Postal Code:	95124
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Application Number:	13623756										
CORRESPONDENCE DATA											
<p>Fax Number:</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Email: Brian@MonolithIC3D.com</p> <p>Correspondent Name: Brian Cronquist</p> <p>Address Line 1: 3555 Woodford Drive</p> <p>Address Line 4: San Jose, CALIFORNIA 95124</p>											
ATTORNEY DOCKET NUMBER:	MONOLITHIC3D-KPCT2US1CON1										
NAME OF SUBMITTER:	Brian Cronquist										
<p>Total Attachments: 4</p> <p>source=MonolithIC3D-kPCT2US1con1assignmentZvis#page1.tif</p> <p>source=MonolithIC3D-kPCT2US1con1assignmentZeevs#page1.tif</p> <p>source=MonolithIC3D-kPCT2US1con1assignmentBrians#page1.tif</p> <p>source=MonolithIC3D-kPCT2US1con1assignmentDeepaks#page1.tif</p>											

OP \$40.00 13623756

ASSIGNMENT

Whereas, I, **Zvi Or-Bach** (hereinafter referred to as Assignor(s)), residing in **San Jose, California**; have made a certain invention, and executed United States Patent Application entitled:

Novel Semiconductor System and Device

as described in U.S. Patent Application Serial No. 13/623,756 and filed on September 20, 2012;
and

Whereas, **MonolithIC 3D™ Inc.**, a company located at 3555 Woodford Drive, San Jose, California 95124 (hereinafter called "Assignee"), desires to acquire the entire right, title, and interest in the application and the invention, and to any applications, patents and/or utility model registrations filed or obtained therefor in every Country (hereinafter called the "Designated Countries").

Now therefore, for valuable consideration, receipt of which is hereby acknowledged,

I/we, the above named Assignor(s), hereby sell, assign and transfer to the above named Assignee the entire right, title and interest to file and/or obtain any applications, patents and/or utility model registrations in the Designated Countries as regards the United States application and the invention disclosed therein (including rights of priority based on the United States application), and I/we will execute without further consideration all papers deemed necessary by the Assignee in connection with such applications, patents and/or utility model registrations in the Designated Countries when called upon to do so by the Assignee.

Signed and Sealed:

INVENTOR:

DATE on

9-25-12

(Zvi

First Name

Middle Initial

Or-Bach)

Last Name

PATENT

REEL: 029040 FRAME: 0237

ASSIGNMENT

Whereas, I, **Ze'ev Wurman** (hereinafter referred to as Assignor(s)), residing in **San Jose, California**; have made a certain invention, and executed United States Patent Application entitled:

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Signed and Sealed:

INVENTOR:

DATE on 9/25/12

(**Ze'ev**

First Name

Middle Initial

Wurman)

Last Name

ASSIGNMENT

Whereas, I, **Brian Cronquist (hereinafter referred to as Assignor(s)), residing in San Jose, California;** have made a certain invention, and executed United States Patent Application entitled:

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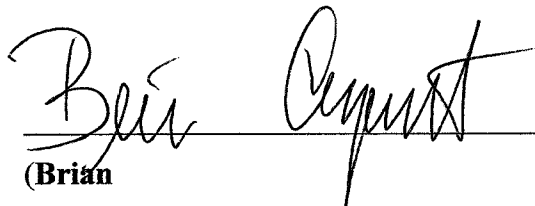
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Signed and Sealed:

INVENTOR:

DATE on

25 Sept 2012



(Brian Cronquist)
First Name Middle Initial Last Name

ASSIGNMENT

Whereas, I, Deepak Sekar (hereinafter referred to as Assignor(s)), residing in San Jose, California; have made a certain invention, and executed United States Patent Application entitled:

Novel Semiconductor System and Device

as described in U.S. Patent Application Serial No. 13/623,756 and filed on September 20, 2012;
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Signed and Sealed:

INVENTOR:

DATE on 26th Sep '2012


(Deepak

Sekar)

First Name

Middle Initial

Last Name